





SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Leadless Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 ⁶⁴
- Weight: 0.001 grams (approximate)

X1-DFN1006-2







Bottom View

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|--------------|------------------|
| BAS40LP-7 | X1-DFN1006-2 | 3000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information

43

43 = Product Type Marking Code Dot Denotes Cathode Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 40 | ٧ |
| Forward Continuous Current | I _{FM} | 200 | mA |
| Forward Surge Current @ t < 1.0s | I _{FSM} | 600 | mA |

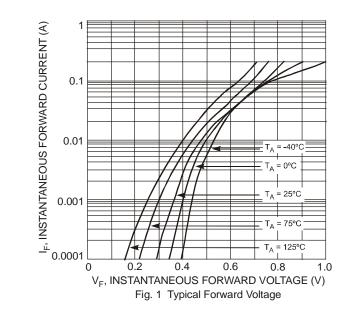
Thermal Characteristics

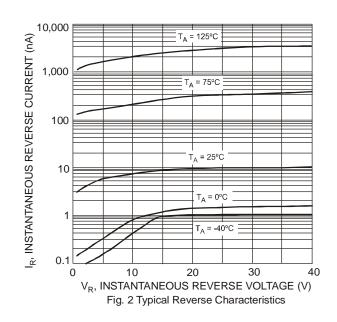
| Characteristic | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Power Dissipation | P _D | 250 | mW |
| Thermal Resistance, Junction to Ambient Air | $R_{	heta JA}$ | 400 | °C/W |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | °C |

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

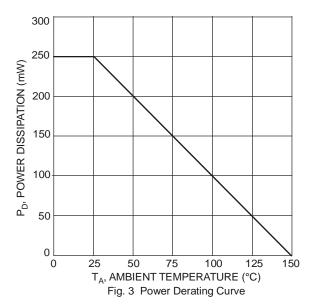
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|-----|-------------|------|--|
| Reverse Breakdown Voltage (Note 5) | $V_{(BR)R}$ | 40 | | | V | $I_R = 10\mu A$ |
| Forward Voltage (Note 3) | V _F | | _ | 380 1000 | mv | $t_p < 300 \mu s$, $I_F = 1.0 mA$ $t_p < 300 \mu s$, $I_F = 40 mA$ |
| Reverse Leakage Current (Note 5) | I _R | _ | 20 | 200 | nA | $t_p < 300 \mu s, V_R = 30 V$ |
| Total Capacitance | C _T | | 2.3 | 5.0 | pF | $V_R = 0V$, $f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | _ | | 5.0 | ns | $I_F = I_R = 10 \text{mA}$ to $I_R = 1.0 \text{mA}$, $R_L = 100 \Omega$ |

Notes: 5. Short duration pulse test used to minimize self-heating effect.



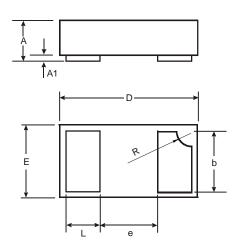






Package Outline Dimensions

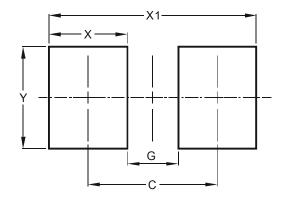
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| X1-DFN1006-2 | | | | | |
|----------------------|------|-------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.47 | 0.53 | 0.50 | | |
| A1 | 0 | 0.05 | 0.03 | | |
| b | 0.45 | 0.55 | 0.50 | | |
| D | 0.95 | 1.075 | 1.00 | | |
| Е | 0.55 | 0.675 | 0.60 | | |
| е | - | - | 0.40 | | |
| L | 0.20 | 0.30 | 0.25 | | |
| R | 0.05 | 0.15 | 0.10 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.70 |
| G | 0.30 |
| Х | 0.40 |
| X1 | 1.10 |
| Υ | 0.70 |



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